

## H11D1/H11D2/H11D3 PHOTOTRANSISTOR, 5.3 KV, TRIOS® HIGH $BV_{CER}$ VOLTAGE OPTOCOUPLER

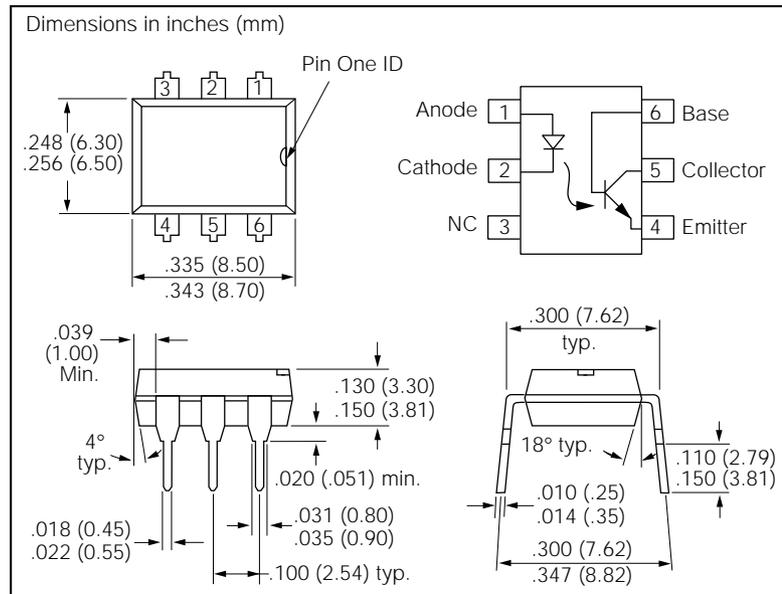
### FEATURES

- CTR at  $I_F=10$  mA,  $BV_{CER}=10$  V:  $\geq 20\%$
- Good CTR Linearity with Forward Current
- Low CTR Degradation
- Very High Collector-Emitter Breakdown Voltage
  - H11D1/H11D2,  $BV_{CER}=300$  V
  - H11D3,  $BV_{CER}=200$  V
- Isolation Test Voltage: 5300 VAC<sub>RMS</sub>
- Low Coupling Capacitance
- High Common Mode Transient Immunity
- Phototransistor Optocoupler in 6 Pin DIP Package with Base Connection
- Field Effect Stable: TRIOS\*
-  VDE 0884 Available with Option 1
- Underwriters Lab File #E52744
- Applications
  - Telecommunications
  - Replace Relays

### DESCRIPTION

The H11D1/2/3 are optocouplers with very high  $BV_{CER}$ . They are intended for telecommunications applications or any DC application requiring a high blocking voltage.

\*TRIOS—TRansparent IO n Shield



### Maximum Ratings ( $T_A=25^\circ\text{C}$ )

#### Emitter

Reverse Voltage .....	6 V
DC Forward Current .....	60 mA
Surge Forward Current ( $t_p \leq 10 \mu\text{s}$ ) .....	2.5 A
Total Power Dissipation .....	100 mW

#### Detector

Collector-Emitter Voltage	
H11D1/2 .....	300 V
H11D3 .....	200 V
Collector-Base Voltage	
H11D1/2 .....	300 V
H11D3 .....	200 V
Emitter-Base Voltage .....	7 V
Collector Current .....	100 mA
Total Power Dissipation .....	300 mW

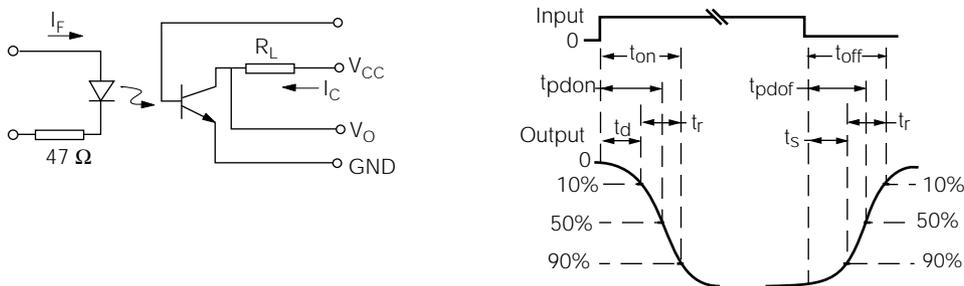
#### Package

Isolation Test Voltage (between emitter and detector refer to climate DIN 40046, part 2, Nov. 74) .....	5300 VAC <sub>RMS</sub>
Insulation Thickness between Emitter and Detector .....	$\geq 0.4$ mm
Creepage Distance .....	$\geq 7$ mm
Clearance Distance .....	$\geq 7$ mm
Comparative Tracking Index (per DIN IEC 112/VDE 0303, part 1) .....	175
Isolation Resistance	
$V_{IO}=500$ V, $T_A=25^\circ\text{C}$ .....	$\geq 10^{12} \Omega$
$V_{IO}=500$ V, $T_A=100^\circ\text{C}$ .....	$\geq 10^{11} \Omega$
Storage Temperature Range .....	$-55^\circ\text{C}$ to $+150^\circ\text{C}$
Operating Temperature Range .....	$-55^\circ\text{C}$ to $+100^\circ\text{C}$
Junction Temperature .....	$100^\circ\text{C}$
Soldering Temperature (max. 10 sec., dip soldering: distance to seating plane $\geq 1.5$ mm) .....	$260^\circ\text{C}$

**Characteristics** ( $T_A=25^\circ\text{C}$ , unless otherwise specified)

	Symbol	Min	Typ	Max	Unit	Condition
<b>Emitter</b>						
Forward Voltage	$V_F$		1.1	1.5	V	$I_F=10\text{ mA}$
Reverse Voltage	$V_R$	6			V	$I_R=10\text{ mA}$
Reverse Current	$I_R$		0.01	10	mA	$V_R=6\text{ V}$
Capacitance	$C_O$		25		pF	$V_R=0\text{ V}, f=1\text{ MHz}$
Thermal Resistance	$R_{thJA}$		750		K/W	
<b>Detector</b>						
Voltage, Collector-Emitter H11D1/H11D2	$BV_{CER}$	300			V	$I_{CE}=1\text{ mA}, R_{BE}=1\text{ M}\Omega$
H11D3		200			V	
Voltage, Emitter-Base	$BV_{EBO}$	7			V	$I_{EB}=100\text{ }\mu\text{A}$
Capacitance	$C_{CE}$ $C_{CB}$ $C_{EB}$		7 8 38		pF pF pF	$V_{CE}=10\text{ V}, f=1\text{ MHz}$ $V_{CB}=10\text{ V}, f=1\text{ MHz}$ $V_{EB}=5\text{ V}, f=1\text{ MHz}$
Thermal Resistance	$R_{thJA}$		250		K/W	
<b>Package</b>						
Coupling Capacitance	$C_C$		0.6		pF	
Coupling Transfer Ratio	$I_C/I_F$	20			%	$I_F=10\text{ mA}, V_{CE}=10\text{ V}, R_{BE}=1\text{ M}\Omega$
Collector-Emitter, Saturation Voltage	$V_{CEsat}$		0.25	0.4	V	$I_F=10\text{ mA}, I_C=0.5\text{ mA}, R_{BE}=1\text{ M}\Omega$
Leakage Current, Collector-Emitter H11D1/H11D2	$I_{CER}$			100	nA	$V_{CE}=200\text{ V}, R_{BE}=1\text{ M}\Omega$
H11D3				100	nA	$V_{CE}=100\text{ V}, R_{BE}=1\text{ M}\Omega$
Leakage Current, Collector-Emitter H11D1/H11D2	$I_{CER}$			250	$\mu\text{A}$	$V_{CE}=200\text{ V}, R_{BE}=1\text{ M}\Omega, T_A=100^\circ\text{C}$
H11D3				250	$\mu\text{A}$	$V_{CE}=100\text{ V}, R_{BE}=1\text{ M}\Omega, T_A=100^\circ\text{C}$

**Figure 1. Switching times measurement-test circuit and waveforms**

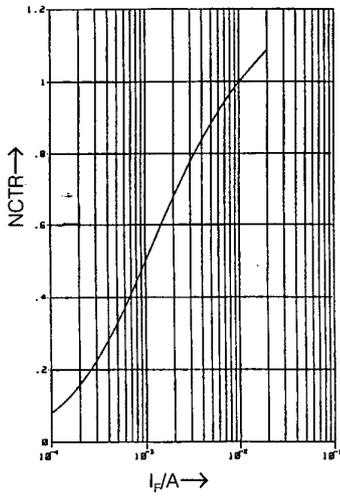


**Switching Times (typ.)**

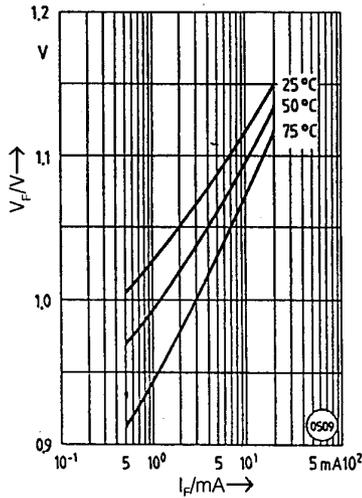
$I_C=2\text{ mA}$  (to be adjusted by varying  $I_F$ ),  $R_L=100\Omega$ ,  
 $T_A=25^\circ\text{C}$ ,  $V_{CC}=10\text{ V}$

Description	Symbol	Values	Unit
Turn-On Time	$t_{ON}$	5	$\mu\text{s}$
Rise Time	$t_R$	2.5	$\mu\text{s}$
Turn-Off Time	$t_{OFF}$	6	$\mu\text{s}$
Fall Time	$t_F$	5.5	$\mu\text{s}$

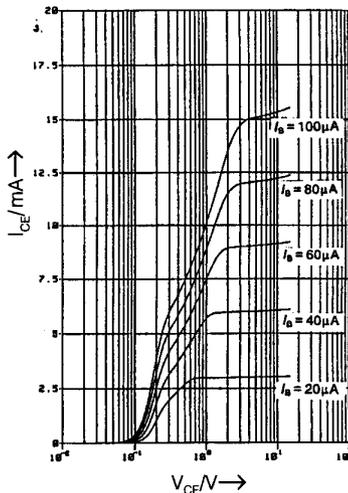
**Figure 2. Current transfer ratio (typ.)**  $V_{CE}=10\text{ V}$ ,  $T_A=25^\circ\text{C}$ , normalized to  $I_F=10\text{ mA}$ ,  $NCTR=f(I_F)$



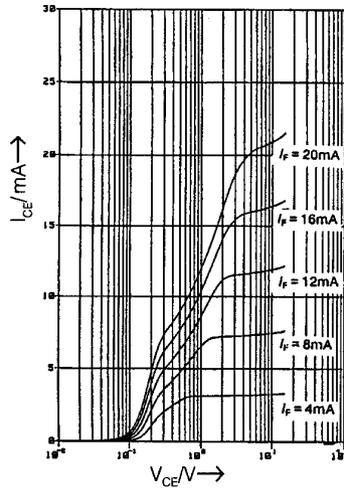
**Figure 3. Diode forward voltage (typ.)**  $V_F=f(I_F, T_A)$



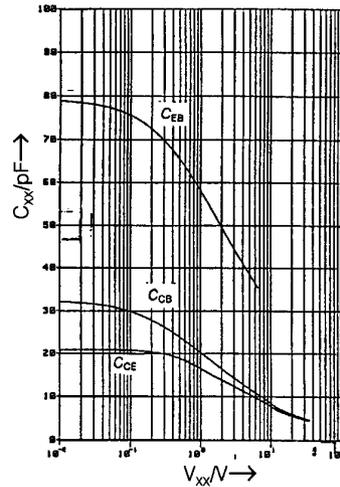
**Figure 4. Output characteristics (typ.)**  $T_A=25^\circ\text{C}$ ,  $I_{CE}=f(V_{CE}, I_B)$



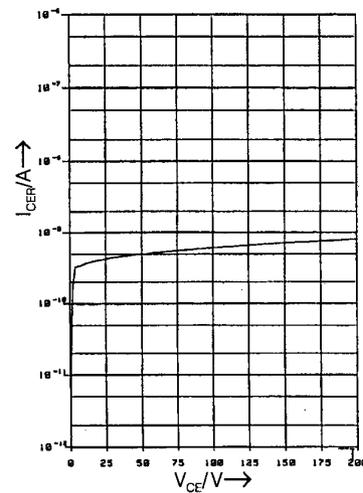
**Figure 5. Output characteristics (typ.)**  $T_A=25^\circ\text{C}$ ,  $I_{CE}=f(V_{CE}, I_F)$



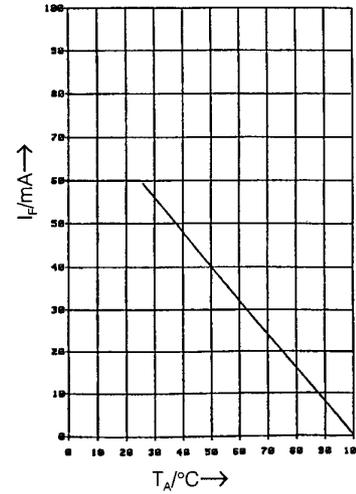
**Figure 6. Transistor capacitances (typ.)**  $T_A=25^\circ\text{C}$ ,  $f=1\text{ MHz}$ ,  $C_{CE}=f(V_{CE})$ ,  $C_{CB}=f(V_{CB})$ ,  $C_{EB}=f(V_{EB})$



**Figure 7. Collector-emitter leakage current (typ.)**  $I_F=0$ ,  $R_{BE}=1\text{ M}\Omega$ ,  $I_{CER}=f(V_{CE})$



**Figure 8. Permissible loss diode**  $I_F=f(T_A)$



**Figure 9. Permissible power dissipation**  $P_{TOT}=f(T_A)$

